K-DING ELECTRONIC CO., LTD



凱鼎電子有限公司

Page:1/3 Revision:A0

MPC-2520AB-XXX-M Power Choke

	Inductance	DC Resi	stance	Heating Rat	ing Current	Saturatio	on Current
Part No	L0(µH)	DCR(mΩ)		Idc(A)		Isat(A)	
	±20%,100KHZ,1V	TYP.	MAX.	TYP.	MAX.	TYP.	MAX.
MPC-2520AB-R22-M	0.22	8	10	7.3	6.57	7	6.3
MPC-2520AB-R33-M	0.33	14	17	5.5	4.95	5.8	5.22
MPC-2520AB-R47-M	0.47	23	28	4.5	4	5	4.5
MPC-2520AB-R50-M	0.5	25	30	4.3	3.87	4.8	4.32
MPC-2520AB-1R0-M	1	45	55	3.1	2.7	3.8	3.3
MPC-2520AB-1R5-M	1.5	58	70	2.7	2.43	2.9	2.61
MPC-2520AB-2R2-M	2.2	86	105	2.3	2	2.5	2.2
MPC-2520AB-3R3-M	3.3	120	1444	1.75	1.55	2	1.8
MPC-2520AB-4R7-M	4.7	200	240	1.5	1.3	1.9	1.5
MPC-2520AB-6R0-M	6	240	275	1.3	1.1	1.7	1.4
MPC-2520AB-100-M	10	400	460	1	0.85	1.3	1

Notes 1.All test date is referenced to 25°C ambient

- 2.Operating temperature range -55°Cto+125°C
- 3.Idc(A):DC current(A)that will cause an approximate $\triangle T$ of 40°C
- 4.Isat(A):DC current(A)that will cause L0 todrop approximately 30%
- 5.The part tenperature (ambient+temp rise)should not exceed 125°C under worst case operating conditions. Circuit design,component placement, PWB trace size and thickness,airflow and other cooling provisions all affect the part temperature.Part temperature should beverified in the end application

K-DING ELECTRONIC CO., LTD

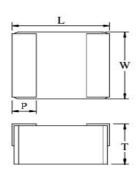




凱鼎電子有限公司

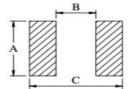
Page:2/3

Revision:A0



Code	Dimensions	
L	2.5±0.3	
W	2.0±0.2	
Т	1.2MAX.	
Р	0.6±0.2	

Unit: mm



Α	2.0	25
В	1.2	
С	2.8	25

Unit: mm

Recommend Land Pattern Dimensions

FEATURES

- Lowest molded heighe(1.2mm)in this package Footprint
- Shielded construction
- Frequency rang up to 3.0MHz
- Lowest DCR/µH,in this package size
- Handles ight transient current spikes without saturation
- Ultra low buzz noise, due to composite constuction
- Encapsulated body offfers improved environmental protection and mositure resistance.
- Higher dielectric withstanding voltage vs.IHLP
- Flame retardant encapsulant(UL94V-0)
- Corrosion resistant package
- Compliant to RoHS directive 2002/95/EC

K-DING ELECTRONIC CO., LTD



凱鼎電子有限公司

Page:3/3

Revision:A0

APPLICTIONS

- PDA/notebook/desktop/server applications
- Hight current POL converters
- Low profile, hig current power supplies
- Battery powered devices
- DC/DC converters in disteibuted power systems
- DC/DC converter for Field Progarammable Gate Array (FAGA)